

HMC687* PRODUCT PAGE QUICK LINKS

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COMPARABLE PARTS

View a parametric search of comparable parts.

EVALUATION KITS

- HMC687LP4 Evaluation Board

DOCUMENTATION

Data Sheet

- HMC687 Data Sheet

REFERENCE MATERIALS

Quality Documentation

- Package/Assembly Qualification Test Report: LP4, LP4B, LP4C, LP4K (QTR: 2013-00487 REV: 04)
- Semiconductor Qualification Test Report: BiCMOS-A (QTR: 2013-00235)

DESIGN RESOURCES

- HMC687 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

View all HMC687 EngineerZone Discussions.

SAMPLE AND BUY

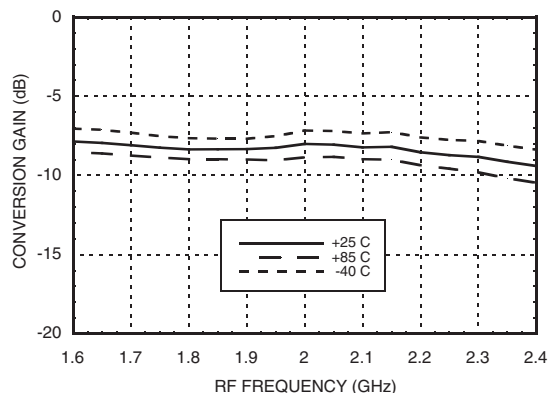
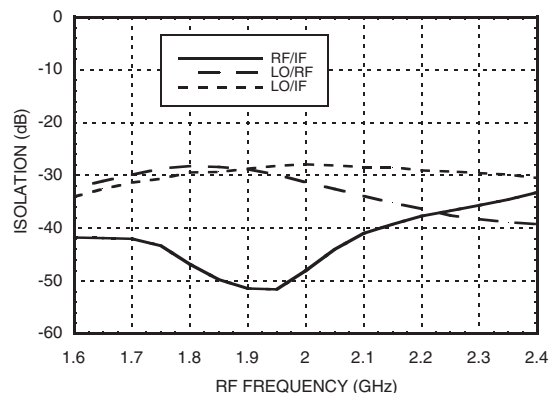
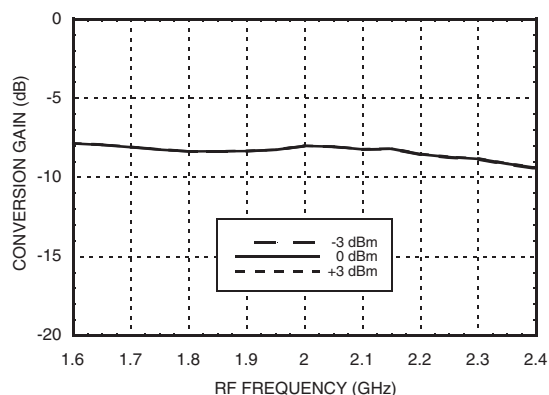
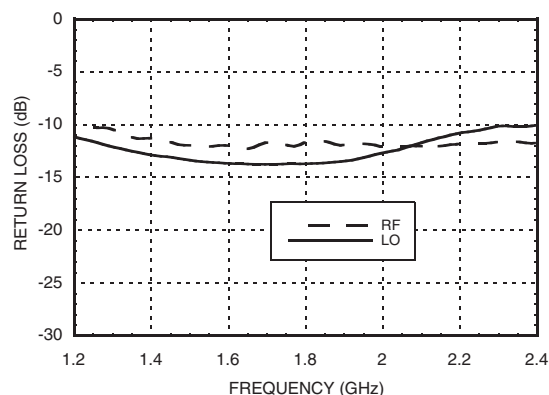
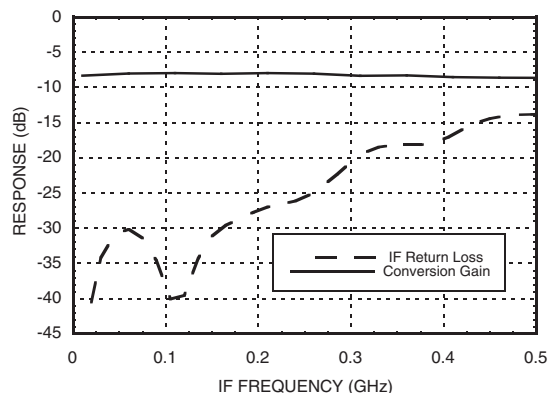
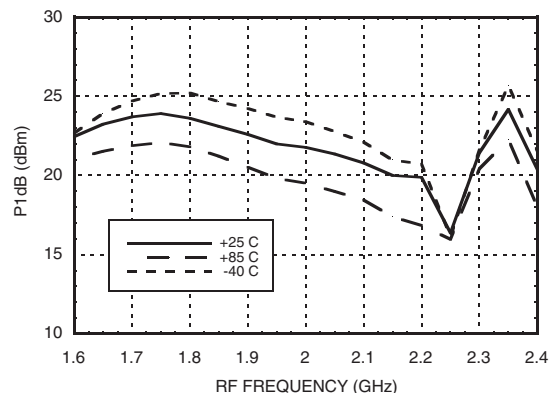
Visit the product page to see pricing options.

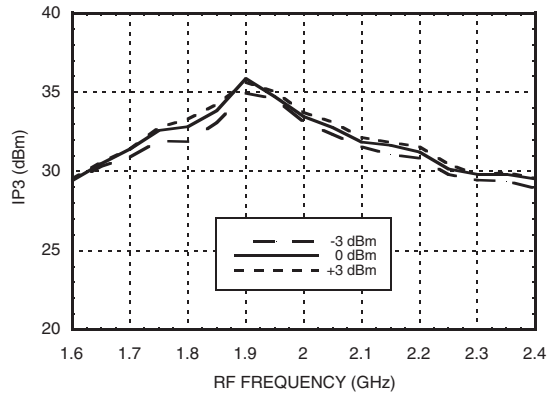
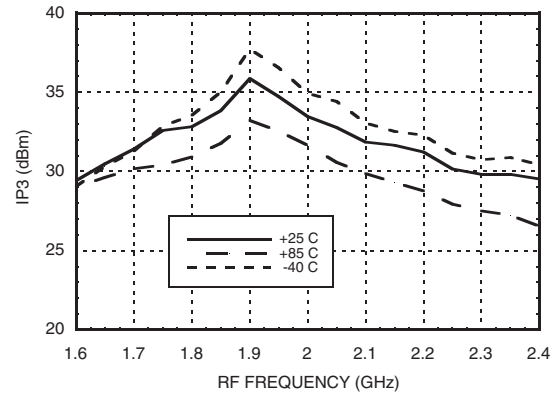
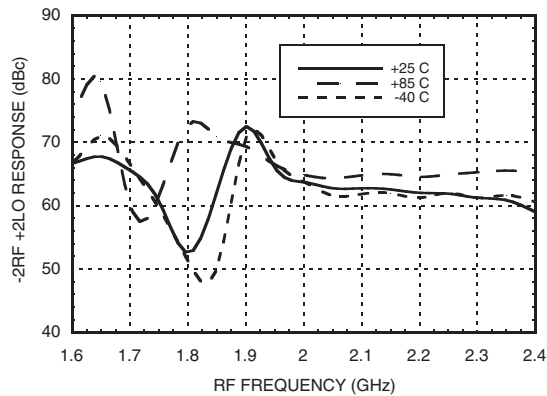
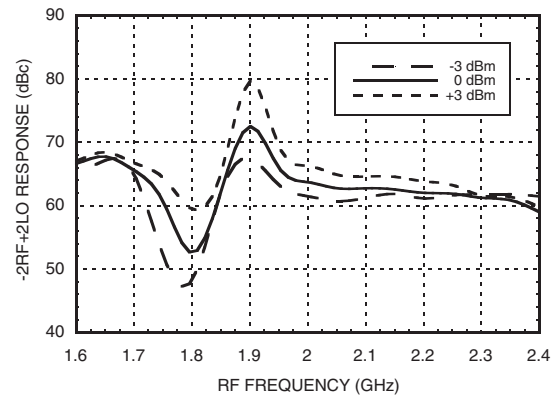
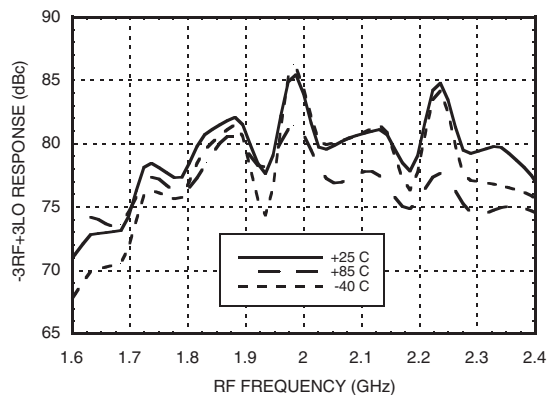
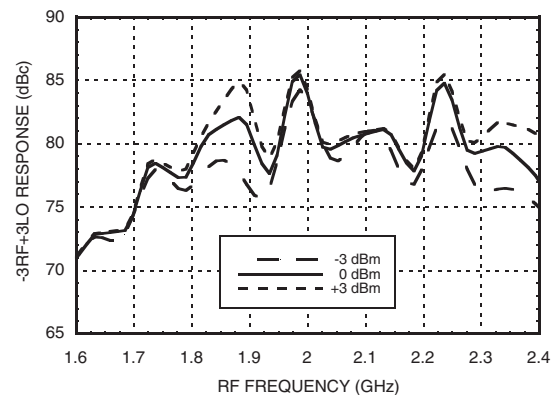
TECHNICAL SUPPORT

Submit a technical question or find your regional support number.

DOCUMENT FEEDBACK

Submit feedback for this data sheet.

Conversion Gain vs. Temperature

Isolation

Conversion Gain vs. LO Drive

Return Loss

IF Bandwidth (LO= 2.2 GHz)

Input P1dB vs. Temperature



**BiCMOS MMIC MIXER W/ INTEGRATED
LO AMPLIFIER, 1.7 - 2.2 GHz**
Input IP3 vs. LO Drive ^[1]

Input IP3 vs. Temperature ^[1]

-2RF +2LO Response vs. Temperature ^[2]

-2RF +2LO Response vs. LO Drive ^[2]

-3RF +3LO Response vs. Temperature ^[2]

-3RF +3LO Response vs. LO Drive ^[2]


[1] Two-tone input power = +9 dBm each tone, 1 MHz spacing. [2] Referenced to RF Input power at 0 dBm

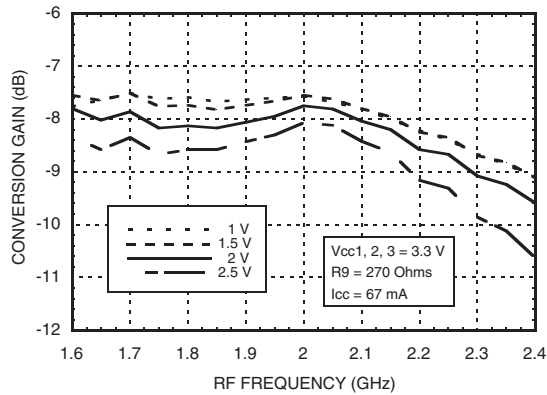
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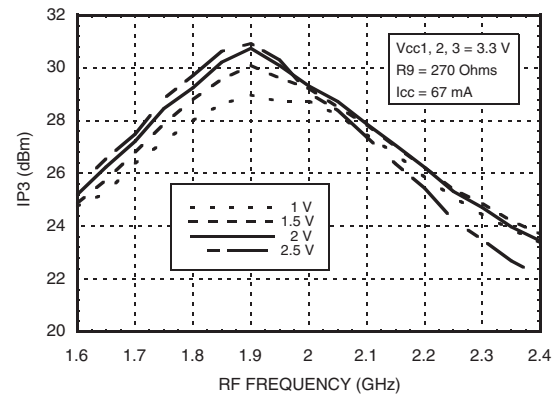
BiCMOS MMIC MIXER W/ INTEGRATED LO AMPLIFIER, 1.7 - 2.2 GHz

Low Power Consumption Performance

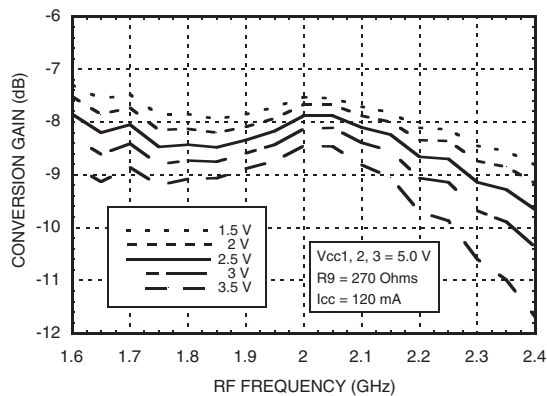
Conversion Gain vs. G_{Bias} Voltage



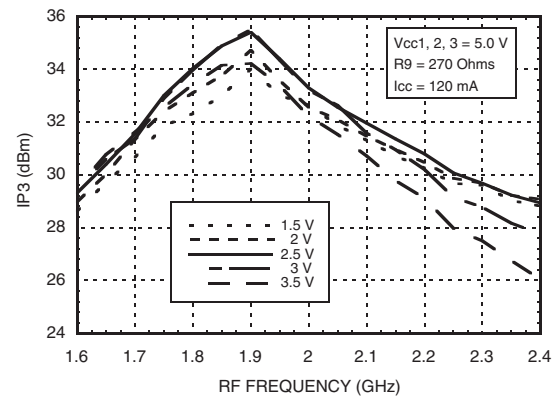
Input IP3 vs. G_{Bias} Voltage ^[1]



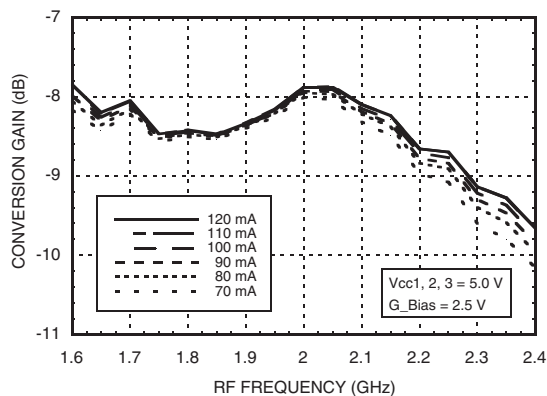
Conversion Gain vs. G_{Bias} Voltage



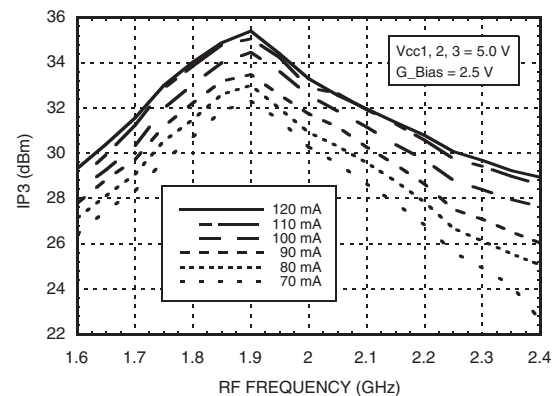
Input IP3 vs. G_{Bias} Voltage ^[1]



Conversion Gain vs. I_{cc}



Input IP3 vs. I_{cc} ^[1]

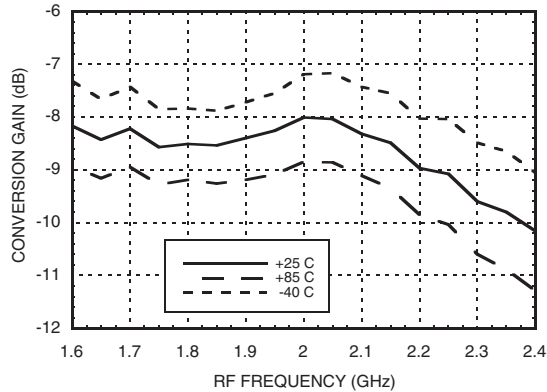


[1] Two-tone input power = +9 dBm each tone, 1 MHz spacing

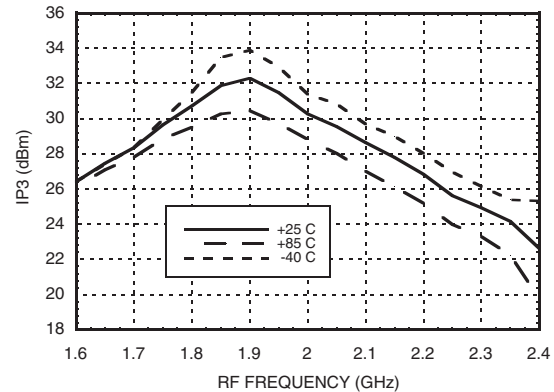
BiCMOS MMIC MIXER W/ INTEGRATED LO AMPLIFIER, 1.7 - 2.2 GHz

Low Power Consumption Performance

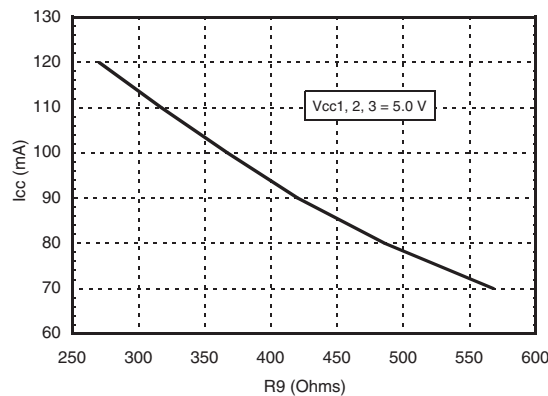
**Conversion Gain vs.
Temperature, $I_{cc} = 70$ mA**



Input IP3 vs. Temperature, $I_{cc} = 70$ mA ^[1]

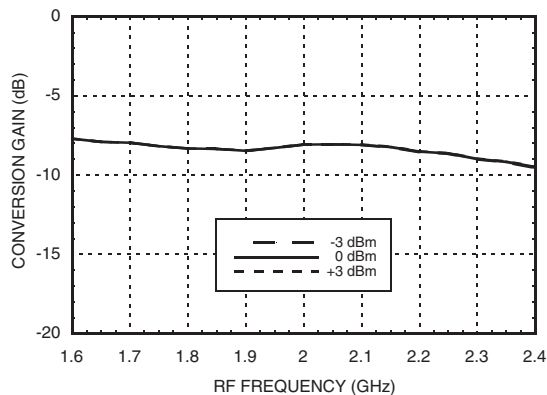


I_{cc} vs. R_9

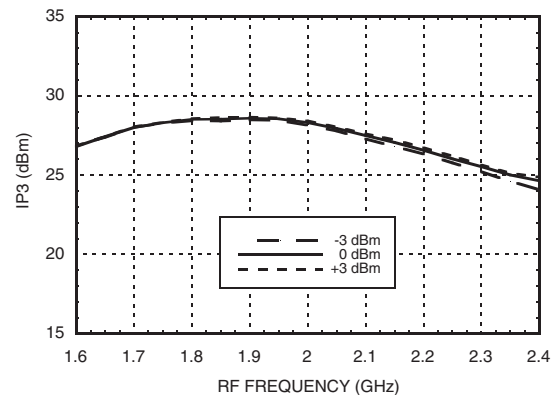


Typical Upconverter Performance

Conversion Gain vs. LO Drive



Input IP3 vs. LO Drive ^[1]



[1] Two-tone input power = +9 dBm each tone, 1 MHz spacing.

**BiCMOS MMIC MIXER W/ INTEGRATED
LO AMPLIFIER, 1.7 - 2.2 GHz**
Absolute Maximum Ratings

RF / IF Input (Vcc1, 2, 3 = +5V)	+23 dBm
LO Drive (Vcc1, 2, 3 = +5V)	+10 dBm
Vcc1,2,3	+5.5V
Channel Temperature	125 °C
Continuous Pdiss (T = 85°C) (derate 20.69 mW/°C above 85°C)	0.83 mW
Thermal Resistance (channel to ground paddle)	48.33 °C/W
Storage Temperature	-65 to 150 °C
Operating Temperature	-40 to +85 °C



**ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS**

Typical Supply Current vs. Vcc

Vcc1, 2, 3 (V)	Icc total (mA)
4.75	113
5.00	120
5.25	127

Downconverter will operate over full voltage range shown above.

MxN Spurious @ IF Port

mRF	nLO				
	0	1	2	3	4
0	xx	20	27	54	28
1	43	0	39	31	57
2	64	60	59	68	87
3	110	81	102	77	96
4	115	129	115	115	112

RF Freq. = 1.9 GHz @ 0 dBm
LO Freq. = 2.1 GHz @ 0 dBm
All values in dBc below IF power level (-1RF + 1LO).

Harmonics of LO

LO Freq. (GHz)	nLO Spur @ RF Port			
	1	2	3	4
1.6	37	25	46	42
1.7	35	24	44	41
1.8	33	23	43	42
1.9	30	22	36	36
2.0	29	23	40	28
2.1	29	24	44	27
2.2	32	24	42	31
2.3	34	24	42	38

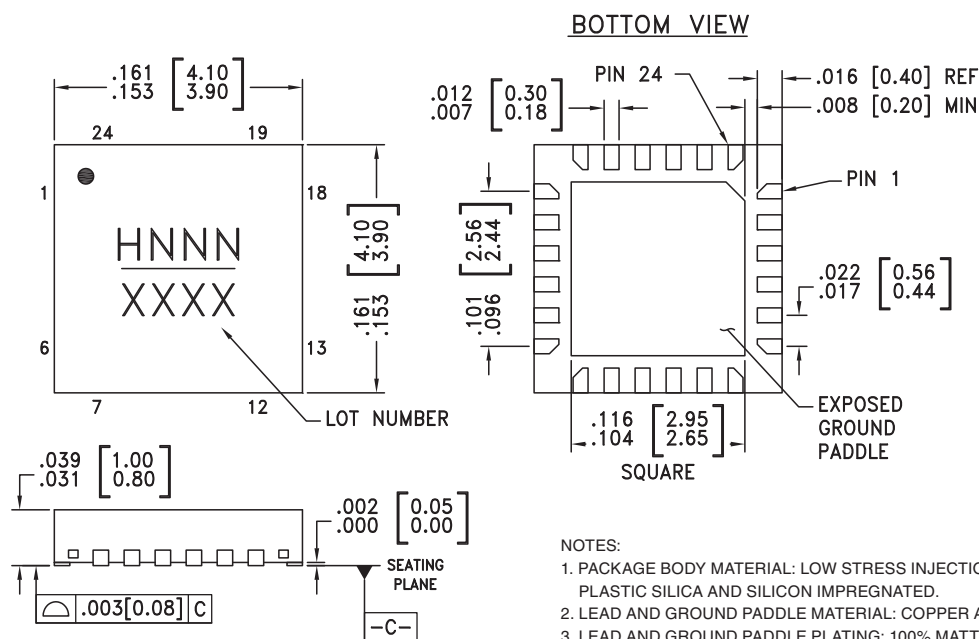
LO = 0 dBm
All values in dBc below input LO level measured at RF port.

[1] Two-tone input power = +9 dBm each tone, 1 MHz spacing.



BiCMOS MMIC MIXER W/ INTEGRATED LO AMPLIFIER, 1.7 - 2.2 GHz

Outline Drawing



NOTES:

1. PACKAGE BODY MATERIAL: LOW STRESS INJECTION MOLDED PLASTIC SILICA AND SILICON IMPREGNATED.
2. LEAD AND GROUND PADDLE MATERIAL: COPPER ALLOY.
3. LEAD AND GROUND PADDLE PLATING: 100% MATTE TIN.
4. DIMENSIONS ARE IN INCHES [MILLIMETERS].
5. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
6. PAD BURR LENGTH SHALL BE 0.15mm MAX.
PAD BURR HEIGHT SHALL BE 0.25mm MAX.
7. PACKAGE WARP SHALL NOT EXCEED 0.05mm
8. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
9. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED PCB LAND PATTERN.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[3]
HMC687LP4	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 ^[1]	H687 XXXX
HMC687LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	H687 XXXX

[1] Max peak reflow temperature of 235 °C


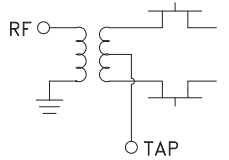
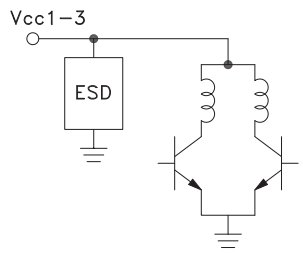
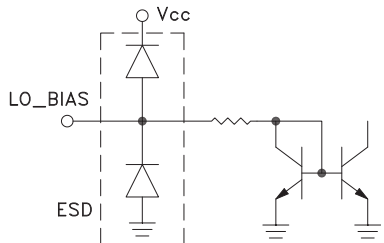
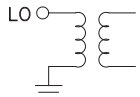
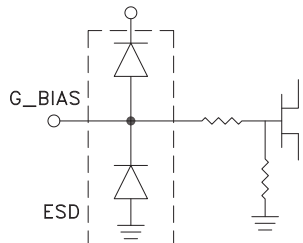
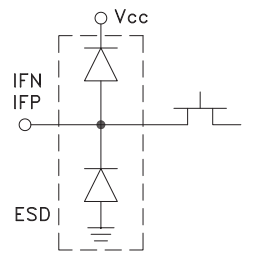
[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

BiCMOS MMIC MIXER W/ INTEGRATED LO AMPLIFIER, 1.7 - 2.2 GHz



Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 6, 7, 11 - 14, 18, 20, 23	N/C	No connection. These pins may be connected to RF ground. Performance will not be affected.	
2, 5, 15, 17	GND	Package bottom must be connected to RF/DC ground.	
3	RF	This pin is matched single-ended 50 Ohm and DC shorted to ground through a balun.	
4	TAP	Center tap of secondary side of the internal RF balun. Short to ground with a zero ohm close to the IC.	
8, 10, 24	Vcc1, Vcc2, Vcc3	Power supply voltage. See application circuit for required external components.	
9	LO_BIAS	LO buffer current adjustment pin. Adjust the LO buffer current through the external resistor R9 shown in the application circuit (connect 270 Ohms for nominal operation). This adjustment allows for a trade-off between power dissipation and linearity performance of the converter.	
16	LO	This pin is matched single-ended 50 Ohm and DC shorted to ground through a balun.	
19	G_BIAS	External bias. See application circuit for recommended external components. Apply +2.5V for nominal operation at 5V supply voltage. G_Bias can be set to between 0 and 5Vdc. The G_bias pin has an internal 15K ohm resistance to ground. This adjustment allows for a trade off between conversion loss and linearity performance of the converter (see figures CG, IP3 vs. G-Bias).	
21, 22	IFN, IFP	Differential IF input / output pins matched to differential 50 Ohms. For applications not requiring operation to DC an off chip DC blocking capacitor should be used.	

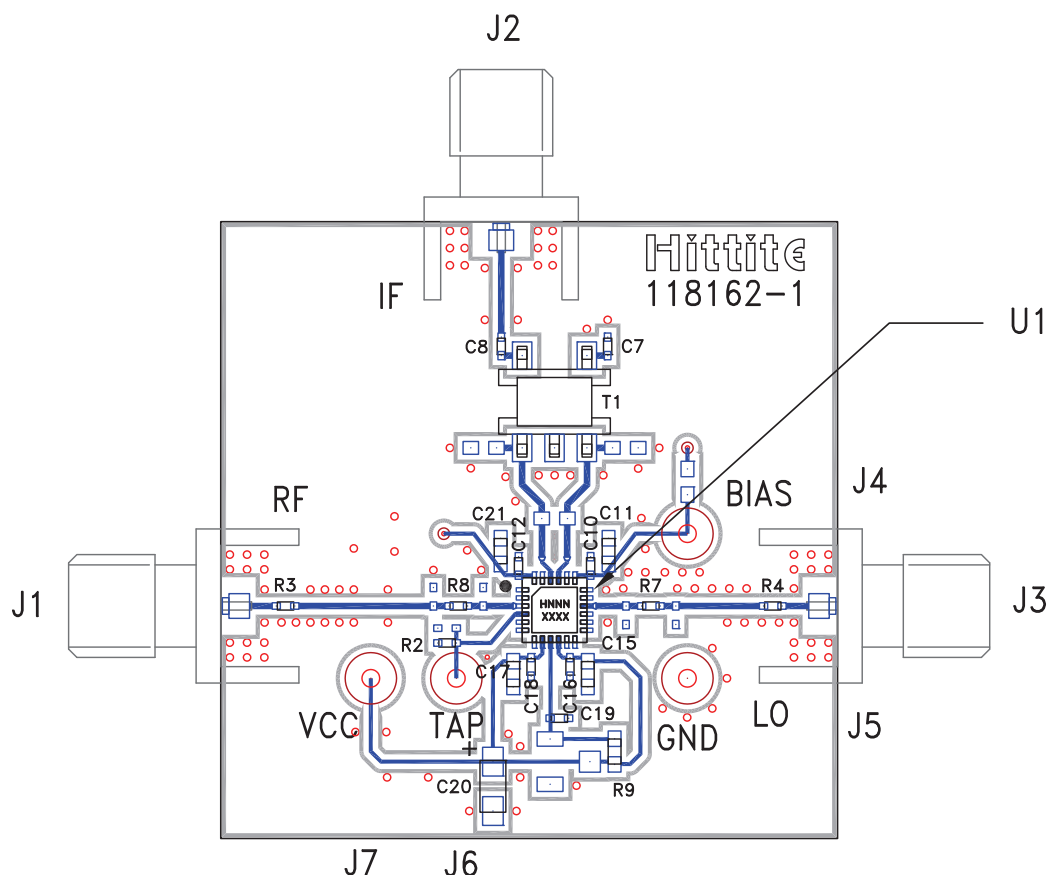
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BiCMOS MMIC MIXER W/ INTEGRATED LO AMPLIFIER, 1.7 - 2.2 GHz



Evaluation PCB



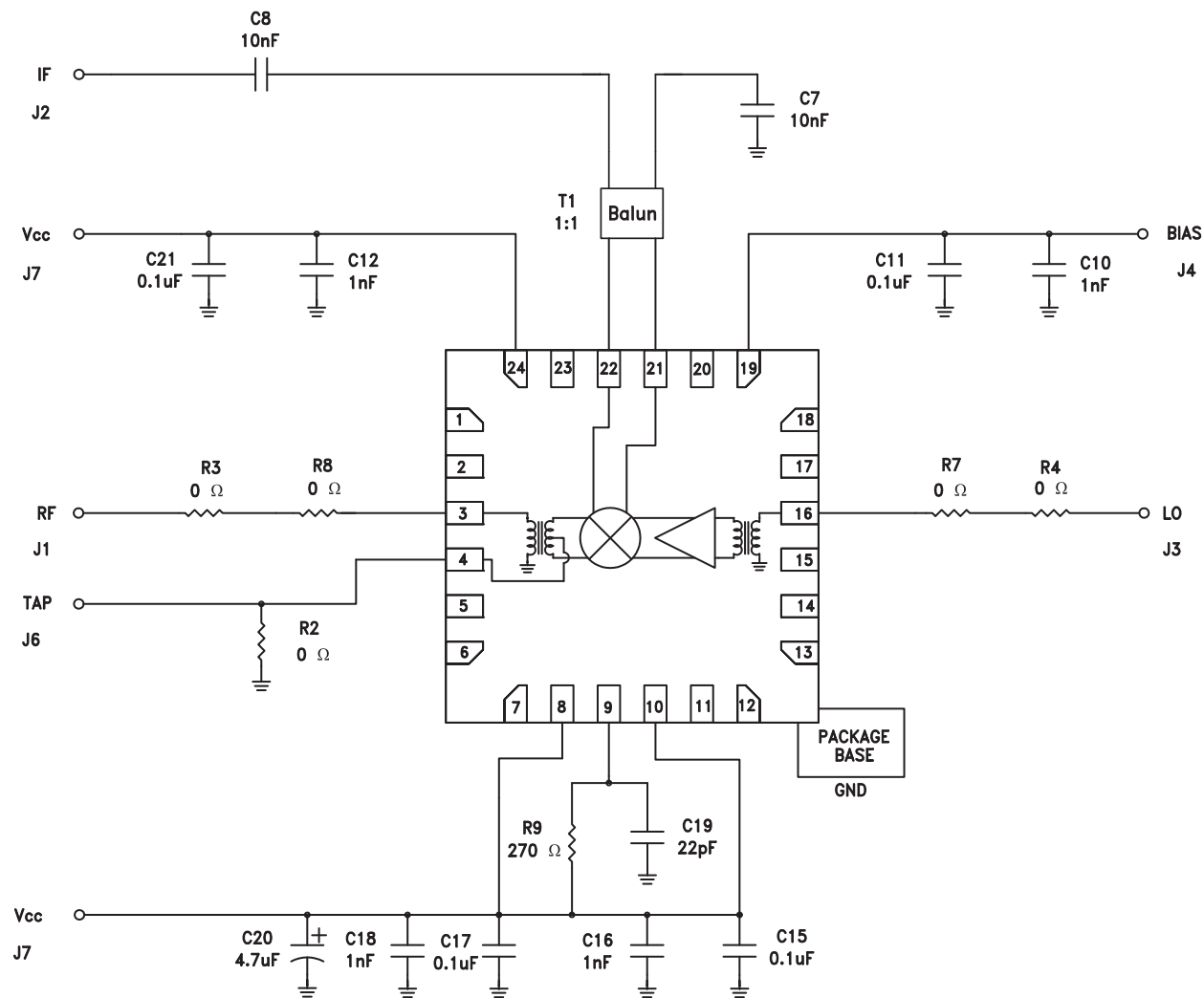
List of Materials for Evaluation PCB 119935 [1]

Item	Description
J1 - J3	SMA Connector
J4 - J7	DC Pin
C19	22 pF Capacitor, 0402 Pkg.
C7, C8	10 nF Capacitor, 0402 Pkg.
C10, C12, C16, C18	1 nF Capacitor, 0402 Pkg.
C11, C15, C17, C21	0.1 μF Capacitor, 0402 Pkg.
C20	4.7 μF Case A, Tantalum
R2 - R4, R7, R8	0 Ohm Resistor, 0402 Pkg.
R9	270 Ohm Resistor, 0603 Pkg.
T1	1:1 Transformer - Tyco MABA CT0039
U1	HMC687LP4(E) Downconverter
PCB [2]	118162 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Arlon 25R, FR4

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

Application Circuit


10

MIXERS - SINGLE & DOUBLE BALANCED - SMT